504862311 04/10/2018

EPAS ID: PAT4909050

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date		
RONGBAO SHI	11/22/2017		
LEI ZHANG	11/23/2017		
YANMEI WANG	11/23/2017		

RECEIVING PARTY DATA

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State/Country:	SINGAPORE
Postal Code:	569059

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15860217

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 1091-2017A0904US

NAME OF SUBMITTER: NA XU

SIGNATURE: /Na Xu/

DATE SIGNED: 04/10/2018

Total Attachments: 4

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Attorney Docket No.: 1091-2017A0904US

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MICHALINA
WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:
Carmera Optical Lens
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on(Application No); and
WHEREAS, AAC Technologies Pte. Ltd., a corporation of <u>Singapore</u> whose post office address is <u>10 Ang Mo Kio Street 65, #01-08 Techpoint, Singapore 569059.</u> (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No, filed
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.
AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No, the filing date and application number of said application when known

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventors:

Name:

Rongbao Shi

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Signature: Rombon Shi

Date:

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Attorney Docket No.: 1091-2017A0904US

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RECORDED: 04/10/2018